

# Woongkyu Lee

## List of Publications by Year in descending order

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45  
papers

1,959  
citations

361296

20  
h-index

243529

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46  
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46  
docs citations

46  
times ranked

1964  
citing authors

#	ARTICLE	IF	CITATIONS
1	Evolution of phases and ferroelectric properties of thin Hf <sub>0.5</sub> Zr <sub>0.5</sub> O <sub>2</sub> films according to the thickness and annealing temperature. Applied Physics Letters, 2013, 102, .	1.5	480
2	Surface and grain boundary energy as the key enabler of ferroelectricity in nanoscale hafnia-zirconia: a comparison of model and experiment. Nanoscale, 2017, 9, 9973-9986.	2.8	249
3	Effect of forming gas annealing on the ferroelectric properties of Hf <sub>0.5</sub> Zr <sub>0.5</sub> O <sub>2</sub> thin films with and without Pt electrodes. Applied Physics Letters, 2013, 102, .	1.5	141
4	Study on the degradation mechanism of the ferroelectric properties of thin Hf <sub>0.5</sub> Zr <sub>0.5</sub> O <sub>2</sub> films on TiN and Ir electrodes. Applied Physics Letters, 2014, 105, 072902.	1.5	133
5	Atomic Layer Deposition of SrTiO <sub>3</sub> Thin Films with Highly Enhanced Growth Rate for Ultrahigh Density Capacitors. Chemistry of Materials, 2011, 23, 2227-2236.	3.2	112
6	Atomic Layer Deposition of SrTiO <sub>3</sub> Films with Cyclopentadienyl-Based Precursors for Metal-Insulator-Metal Capacitors. Chemistry of Materials, 2013, 25, 953-961.	3.2	69
7	Structure and Electrical Properties of Al-Doped HfO <sub>2</sub> and ZrO <sub>2</sub> Films Grown via Atomic Layer Deposition on Mo Electrodes. ACS Applied Materials & Interfaces, 2014, 6, 22474-22482.	4.0	63
8	Improvement in the leakage current characteristic of metal-insulator-metal capacitor by adopting RuO <sub>2</sub> film as bottom electrode. Applied Physics Letters, 2011, 99, .	1.5	58
9	Conformal Formation of (GeTe <sub>2</sub> ) <sub>1-x</sub> (Sb <sub>2</sub> Te <sub>3</sub> ) <sub>x</sub> Layers by Atomic Layer Deposition for Nanoscale Phase Change Memories. Chemistry of Materials, 2012, 24, 2099-2110.	3.2	48
10	Influences of metal, non-metal precursors, and substrates on atomic layer deposition processes for the growth of selected functional electronic materials. Coordination Chemistry Reviews, 2013, 257, 3154-3176.	9.5	48
11	Cs <sub>2</sub> Sn <sub>6</sub> -Encapsulated Multidye-Sensitized All-Solid-State Solar Cells. ACS Applied Materials & Interfaces, 2019, 11, 21424-21434.	4.0	35
12	Improved Initial Growth Behavior of SrO and SrTiO <sub>3</sub> Films Grown by Atomic Layer Deposition Using {Sr(tmhd)} <sub>2</sub> as Sr-Precursor. Chemistry of Materials, 2015, 27, 3881-3891.	3.2	32
13	Evaluating the Top Electrode Material for Achieving an Equivalent Oxide Thickness Smaller than 0.4 nm from an Al-Doped TiO <sub>2</sub> Film. ACS Applied Materials & Interfaces, 2014, 6, 21632-21637.	4.0	31
14	Role of Interfacial Reaction in Atomic Layer Deposition of TiO <sub>2</sub> Thin Films Using Ti(O-iPr) <sub>2</sub> (tmhd) <sub>2</sub> on Ru or RuO <sub>2</sub> Substrates. Chemistry of Materials, 2011, 23, 976-983.	3.2	26
15	The mechanism for the suppression of leakage current in high dielectric TiO <sub>2</sub> thin films by adopting ultra-thin HfO <sub>2</sub> films for memory application. Journal of Applied Physics, 2011, 110, 024105.	1.1	26
16	Growth of Conductive SrRuO <sub>3</sub> Films by Combining Atomic Layer Deposited SrO and Chemical Vapor Deposited RuO <sub>2</sub> Layers. Chemistry of Materials, 2012, 24, 4686-4692.	3.2	26
17	Study on Initial Growth Behavior of RuO <sub>2</sub> Film Grown by Pulsed Chemical Vapor Deposition: Effects of Substrate and Reactant Feeding Time. Chemistry of Materials, 2012, 24, 1407-1414.	3.2	23
18	Controlling the Electrical Characteristics of ZrO <sub>2</sub> /Al <sub>2</sub> O <sub>3</sub> /ZrO <sub>2</sub> Capacitors by Adopting a Ru Top Electrode Grown via Atomic Layer Deposition. Physica Status Solidi - Rapid Research Letters, 2019, 13, 1800454.	1.2	23

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19	Electrical properties of TiO <sub>2</sub> -based MIM capacitors deposited by TiCl <sub>4</sub> and TTIP based atomic layer deposition processes. <i>Microelectronic Engineering</i> , 2011, 88, 1514-1516.	1.1	21
20	Controlling the Al-Doping Profile and Accompanying Electrical Properties of Rutile-Phased TiO <sub>2</sub> Thin Films. <i>ACS Applied Materials &amp; Interfaces</i> , 2014, 6, 7910-7917.	4.0	21
21	Nanoscale Characterization of TiO <sub>2</sub> Films Grown by Atomic Layer Deposition on RuO <sub>2</sub> Electrodes. <i>ACS Applied Materials &amp; Interfaces</i> , 2014, 6, 2486-2492.	4.0	21
22	Controlling the initial growth behavior of SrTiO <sub>3</sub> films by interposing Al <sub>2</sub> O <sub>3</sub> layers between the film and the Ru substrate. <i>Journal of Materials Chemistry</i> , 2012, 22, 15037.	6.7	19
23	CsPbBr <sub>3</sub> Perovskite Quantum Dot Light-Emitting Diodes Using Atomic Layer Deposited Al <sub>2</sub> O <sub>3</sub> and ZnO Interlayers. <i>Physica Status Solidi - Rapid Research Letters</i> , 2020, 14, 1900573.	1.2	19
24	Impact of Bimetal Electrodes on Dielectric Properties of TiO <sub>2</sub> and Al-Doped TiO <sub>2</sub> Films. <i>ACS Applied Materials &amp; Interfaces</i> , 2012, 4, 4726-4730.	4.0	18
25	Chemistry of active oxygen in RuO <sub>x</sub> and its influence on the atomic layer deposition of TiO <sub>2</sub> films. <i>Journal of Materials Chemistry C</i> , 2014, 2, 9993-10001.	2.7	18
26	MoO <sub>2</sub> as a thermally stable oxide electrode for dynamic random-access memory capacitors. <i>Journal of Materials Chemistry C</i> , 2018, 6, 13250-13256.	2.7	18
27	Resistance switching behavior of atomic layer deposited SrTiO <sub>3</sub> film through possible formation of Sr <sub>2</sub> Ti <sub>6</sub> O <sub>13</sub> or Sr <sub>1</sub> Ti <sub>11</sub> O <sub>20</sub> phases. <i>Scientific Reports</i> , 2016, 6, 20550.	1.6	17
28	Electrical Properties of ZrO <sub>2</sub> /Al <sub>2</sub> O <sub>3</sub> /ZrO <sub>2</sub> -Based Capacitors with TiN, Ru, and TiN/Ru Top Electrode Materials. <i>Physica Status Solidi - Rapid Research Letters</i> , 2018, 12, 1800356.	1.2	16
29	Growth and Phase Separation Behavior in Ge-Doped Sb <sup>~</sup> Te Thin Films Deposited by Combined Plasma-Enhanced Chemical Vapor and Atomic Layer Depositions. <i>Journal of Physical Chemistry C</i> , 2010, 114, 17899-17904.	1.5	15
30	Quantitative Analysis of the Incorporation Behaviors of Sr and Ti Atoms During the Atomic Layer Deposition of SrTiO <sub>3</sub> Thin Films. <i>ACS Applied Materials &amp; Interfaces</i> , 2018, 10, 8836-8844.	4.0	15
31	Processing, Structure, and Transistor Performance: Combustion versus Pulsed Laser Growth of Amorphous Oxides. <i>ACS Applied Electronic Materials</i> , 2019, 1, 548-557.	2.0	15
32	Effect of Growth Temperature during the Atomic Layer Deposition of the SrTiO <sub>3</sub> Seed Layer on the Properties of RuO <sub>2</sub> /SrTiO <sub>3</sub> /Ru Capacitors for Dynamic Random Access Memory Applications. <i>ACS Applied Materials &amp; Interfaces</i> , 2018, 10, 41544-41551.	4.0	13
33	Investigating the Reasons for the Difficult Erase Operation of a Charge-Trap Flash Memory Device with Amorphous Oxide Semiconductor Thin-Film Channel Layers. <i>Physica Status Solidi - Rapid Research Letters</i> , 2021, 15, 2000549.	1.2	13
34	Substrate-Dependent Growth Behavior of Atomic-Layer-Deposited Zinc Oxide and Zinc Tin Oxide Thin Films for Thin-Film Transistor Applications. <i>Journal of Physical Chemistry C</i> , 2020, 124, 26780-26792.	1.5	12
35	Enhanced Brightness and Device Lifetime of Quantum Dot Light-Emitting Diodes by Atomic Layer Deposition. <i>Advanced Materials Interfaces</i> , 2020, 7, 2000343.	1.9	12
36	Asymmetry in electrical properties of Al-doped TiO <sub>2</sub> film with respect to bias voltage. <i>Physica Status Solidi - Rapid Research Letters</i> , 2015, 9, 410-413.	1.2	10

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37	Atomic layer deposition of TiO <sub>2</sub> and Al-doped TiO <sub>2</sub> films on Ir substrates for ultralow leakage currents. <i>Physica Status Solidi - Rapid Research Letters</i> , 2011, 5, 262-264.	1.2	9
38	Reducing the nano-scale defect formation of atomic-layer-deposited SrTiO <sub>3</sub> films by adjusting the cooling rate of the crystallization annealing of the seed layer. <i>Thin Solid Films</i> , 2015, 589, 723-729.	0.8	9
39	Substrate Effects on the Growth Behavior of Atomic-Layer-Deposited Ru Thin Films Using RuO <sub>4</sub> Precursor and N <sub>2</sub> /H <sub>2</sub> Mixed Gas. <i>Journal of Physical Chemistry C</i> , 2019, 123, 22539-22549.	1.5	8
40	Leakage Current Control of SrTiO <sub>3</sub> Thin Films through Al Doping at the Interface between Dielectric and Electrode Layers via Atomic Layer Deposition. <i>Physica Status Solidi - Rapid Research Letters</i> , 2019, 13, 1900373.	1.2	5
41	Effect of the Annealing Temperature of the Seed Layer on the Following Main Layer in Atomic-Layer-Deposited SrTiO <sub>3</sub> Thin Films. <i>Physica Status Solidi - Rapid Research Letters</i> , 2019, 13, 1800557.	1.2	3
42	CsPbBr <sub>3</sub> Perovskite Quantum Dot Light-Emitting Diodes Using Atomic Layer Deposited Al <sub>2</sub> O <sub>3</sub> and ZnO Interlayers. <i>Physica Status Solidi - Rapid Research Letters</i> , 2020, 14, 2070012.	1.2	3
43	Trap Reduction through O <sub>3</sub> Post-Deposition Treatment of Y <sub>2</sub> O <sub>3</sub> Thin Films Grown by Atomic Layer Deposition on Ge Substrates. <i>Advanced Electronic Materials</i> , 2021, 7, 2000819.	2.6	3
44	Comparison of high-k Y <sub>2</sub> O <sub>3</sub> /TiO <sub>2</sub> bilayer and Y-doped TiO <sub>2</sub> thin films on Ge substrate. <i>Journal Physics D: Applied Physics</i> , 2021, 54, 185110.	1.3	2
45	Light-Emitting Diodes: Enhanced Brightness and Device Lifetime of Quantum Dot Light-Emitting Diodes by Atomic Layer Deposition ( <i>Adv. Mater. Interfaces</i> 12/2020). <i>Advanced Materials Interfaces</i> , 2020, 7, 2070067.	1.9	1